



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:

Inventors: Wei Pan, David Russell Evans and  
Sheng Teng Hsu

Serial No: 09/978,434

Filed: October 16, 2001

Title: METHOD OF CONTROLLING THE  
INITIAL GROWTH OF CVD COPPER  
FILMS BY SURFACE TREATMENT  
OF BARRIER METALS FILMS

COPY OF PAPERS  
ORIGINALLY FILED

PATENT APPLICATION

Attorney Docket No.  
SLA0499

**RECEIVED**  
MAR 25 2002  
TC 1700

**SUPPLEMENTAL DECLARATION UNDER 37 C.F.R. §1.67(a)**

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if one name is listed below), or the first and joint inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled,

METHOD OF CONTROLLING THE INITIAL GROWTH OF CVD COPPER FILMS BY  
SURFACE TREATMENT OF BARRIER METALS FILMS

the specification of which (check applicable ones):

- ☐ is attached hereto;
- ☒ was filed with the above-identified "Filed" date and assigned the above-identified "Serial No.";
- ☐ was amended on (or amended through) \_\_\_\_\_.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge the duty to disclose information which is material to the examination of the application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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or first inventor:

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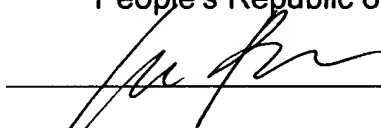
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Date:

2/28/02

\*\*\*\*\*

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